

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAMILTON BONADUZ AG	01/27/2015
RECEIVING PARTY DATA	
Name:	CSEM CENTRE SUISSE D'ELECTRONIQUE ET DE MICROTECHNIQUE SA - RECHERCHE ET DÉVELOPPEMENT
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	8656792
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DATE SIGNED:	03/11/2015
Total Attachments: 1	
source=US8656792-transfer-of-ownership#page1.tif	

Declaration of Assignment

The Assignor,

HAMILTON Bonaduz AG

Via Crusch 8, CH-7408 Bonaduz

is the owner of the US Patent Application n° US 8,656,792 granted on February 25th 2014 and hereby declares that it assigns with all rights and duties the said patent application to the assignee

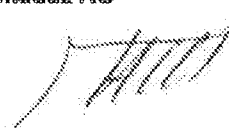
CSEM Centre Suisse d'Electronique et de Microtechnique SA – Recherche et Développement

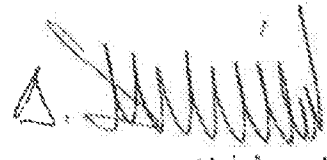
Rue Jaquet-Droz 1, CH-2002 Neuchâtel

To register the assignment and to mention this fact where necessary, all power is bestowed on the holder of an original of the present document.

Place, Date *Bonaduz 27.1.2015*

HAMILTON Bonaduz AG


Radi Hoffmann
VP R&D


Andreas Diemand
CEO

Declaration of Acceptance

We herewith accept the above assignment

Place, Date, *Alpach, 9.3.2015*

CSEM Centre Suisse d'Electronique et de Microtechnique SA- Recherche et Développement


Philippe Steiert
Director of Regional Centers


Helmut F. Knapp
Deputy Division Head
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